

EIRCON 2021

ENGINEERING INTERNATIONAL RESEARCH CONFERENCE



virtual

October 27 – 29

Lima - Perú

CALL FOR PAPERS

We are pleased and honored to invite you to join the second edition of the International Conference on Engineering Research, EIRCON 2021, which will take place on October 27-29, 2021 and will be held in a virtual environment for the security of our community and to provide an inclusive experience.

This conference is organized by the Universidad Autónoma del Perú and the IEEE - Peru Section. It focuses mainly on the different fields of Engineering, such as Systems Engineering, Industrial Engineering, Civil Engineering and Architecture. Its objective is to promote experiences, concepts and advanced technologies that allow the development of technologies for the benefit of society.

Topics of interest include but are not limited to:

- Smart IoT Systems & Applications
- Internet of Things: From Device to Edge and Cloud.
- Artificial Intelligence, Machine Learning, Cognitive Computing, and Advanced Analytics.
- Virtual and Augmented Reality.
- E-learning and Education.
- Public Health Informatics.
- Industrial and Systems Engineering.
- Industrial automation and control.
- Information technology in infrastructure and construction management.
- Complexity in architectural design.
- Complexity in building technology.

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IMPORTANT DATES

Paper Submission Deadline:
August 05

Notification of acceptance:
September 20

Final paper submission deadline:
October 03

Author's registration deadline:
October 10

Oral presentations:
October 27 - 29

Review

All submitted articles are evaluated in a blind peer review process. They must be submitted using the EasyChair System.

<https://easychair.org/conferences/?conf=2021eircon>.

Registration

All accepted papers will need one associated registration with the Call For Papers EIRCON 2021 for being included in the technical program and conference proceedings.

Submission

The official language of EIRCON is ENGLISH, written and oral. Articles should not exceed four (4) pages, according to the IEEE format: <https://www.ieee.org/conferences/publishing/templates.html>. The maximum number of authors per paper is four (4).

Publication and Indexing

All articles in English accepted and registered at EIRCON 2021 will be published in the proceedings and submitted to IEEE Xplore®. The content published in the IEEE Xplore® is shared for indexing with Scopus, Clarivate Analytics (CPCI-Web of Science) among other databases.

ORGANIZING COMMITTEE

CONFERENCE CHAIR:	Michael Cabanillas Carbonell	mcabanillas@ieee.org
CONFERENCE CO-CHAIR:	Adolfo Arana Sánchez	adolfo.arana@autonoma.pe
PROGRAM CHAIR:	Reynaldo Sal y Rosas Reyes	reynaldo.salyrosas@ieee.org
PUBLICATION CHAIR:	José Durán Talledo	joseduran@ieee.org
CONFERENCE TREASURER:	Romel Jimenez Paredes	rjimenez@ieee.org
INFORMATION CONTACT PERSON:	Denilson Contreras Choccata	denilson.contreras@autonoma.pe
	Adonis Ventocilla Sánchez	adonis.ventocilla@ieee.org

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